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STMicroelectronics STTH20003TV1

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STTH20003TV

Ultrafast high voltage rectifier

Mian product characteristics

I _{F(AV)}	up to 2 x 100 A
V _{RRM}	300 V
T _j (max)	150° C
V _F (typ)	0.95 V
t _{rr} (max)	90 ns

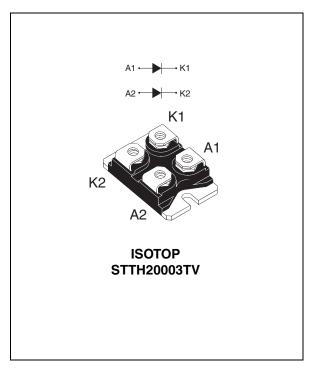
Features and benefits

- Combines highest recovery and reverse voltage performance
- Ultrafast, soft and noise-free recovery
- Package insulation voltage 2500 V_{rms}
- low inductance and low capacitance allow simpler layout

Description

Dual rectifiers suited for Switch Mode Power Supply and high frequency DC to DC converters.

Packaged in ISOTOP™, this device is intended for use in low voltage, high frequency inverters, free wheeling operation, welding equipment and telecom power supplies.



Order codes

Part number	Marking
STTH20003TV	STTH20003TV

Table 1. Absolute ratings (limiting values, per diode, $T_c = 25^{\circ}$ C unless otherwise stated)

Symbol	Param	Value	Unit		
V _{RRM}	Repetitive peak reverse voltage			300	V
I _{F(RMS)}	RMS forward current			180	Α
	Average forward current	$T_{c} = 85^{\circ} \text{ C } \delta = 0.5$	Per diode	100	Α
IF(AV)	I _{F(AV)} Average forward current		Per device	200	A
I _{FSM}	Surge non repetitive forward current $t_p = 10 \text{ ms sinusoidal}$		100	Α	
T _{stg}	Storage temperature range	-55 to + 150	° C		
Tj	Maximum operating junction temperature			150	° C

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September 2006 Rev 2 1/7



Characteristics STTH20003TV

1 Characteristics

Table 2. Thermal resistance

Symbol	bol Parameter		Value (max).	Unit
В	Lunckion to coop	Per diode	0.55	
R _{th(j-c)}	Junction to case	Total	0.35	°C/W
R _{th(c)}	Coupling		0.1	

When diodes 1 and 2 are used simultaneously:

 Δ Tj(diode 1) = P(diode 1) x R_{th(j-c)}(Per diode) + P(diode 2) x R_{th(c)}

Table 3. Static electrical characteristics (per diode)

Symbol	Parameter	Test conditions		Min.	Тур	Max.	Unit
I _R ⁽¹⁾	Reverse leakage	T _j = 25° C	V _B = 300 V			200	μΑ
'R'	T _j = 125	T _j = 125° C	VR = 300 V		0.2	2	mA
V _E (2)	(2) Forward voltage drop	$T_j = 25^{\circ} \text{ C}$ $I_F = 100 \text{ A}$			1.20	V	
v _F , / Folward voltage drop	T _j = 150° C	1F = 100 A		0.8	0.95	V	

^{1.} Pulse test: $t_p = 5$ ms, $\delta < 2\%$

To evaluate the conduction losses use the following equation:

 $P = 0.75 \times I_{F(AV)} + 0.0020 I_{F^2(RMS)}$

Table 4. Dynamic characteristics (per diode)

Symbol	Parameter	Test conditions			Тур	Max	Unit
	Povorco rocovory		$I_F = 0.5 \text{ A}$ $I_{rr} = 0.25 \text{ A}$ $I_R = 1 \text{ A}$		55		
t _{rr}	Reverse recovery time		$I_F = 1 \text{ A} dI_F/dt = -50 \text{ A/}\mu\text{s}$ $V_R = 30 \text{ V}$			90	ns
I _{RM}	Current		$I_F = 100 \text{ A}$ $V_R = 200 \text{ V}$ $dI_F/dt = -200 \text{ A}/\mu\text{s}$			18	Α
S _{factor}	Softness factor	T _j = 125° C	$I_F = 100 \text{ A}$ $V_R = 200 \text{ V}$ $dI_F/dt = -200 \text{ A}/\mu\text{s}$		0.3		
t _{fr}	Forward recovery time	T _j = 25° C	$I_F = 100 \text{ A}$ $dI_F/dt = 200 \text{ A/}\mu\text{s}$ $V_{FR} = 1.1 \text{ x } V_{Fmax}$			1400	ns
V _{FP}	Forward recovery voltage	T _j = 25° C	I_F = 100 A dI_F/dt = 200 A/ μ s V_{FR} = 1.1 x V_{Fmax}			5	V

^{2.} Pulse test: $t_p = 380 \mu s$, $\delta < 2\%$

STTH20003TV Characteristics

Figure 1. Conduction losses versus average forward current (per diode)

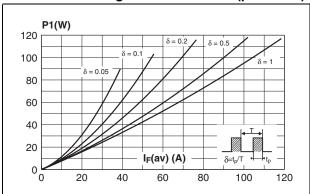


Figure 2. Forward voltage drop versus forward current (per diode)

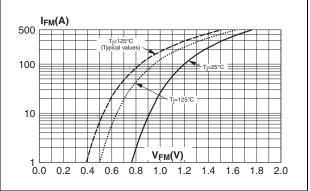
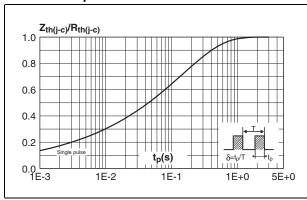


Figure 3. Relative variation of thermal impedance junction to case versus pulse duration

Figure 4. Peak reverse recovery current versus $\mathrm{dI}_{\mathrm{F}}/\mathrm{dt}$ (90% confidence, per diode)



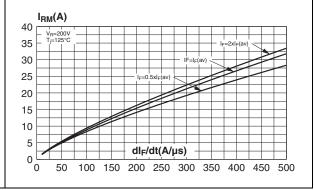


Figure 5. Reverse recovery time versus dI_F/dt (90% confidence, per diode)

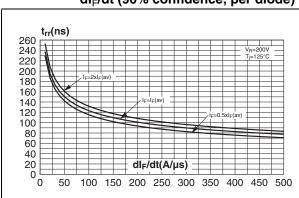
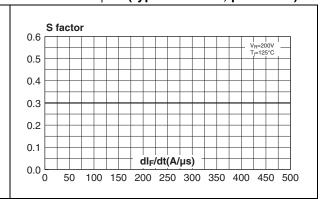


Figure 6. Softness factor (t_b/t_a) versus dl_F/dt (typical values, per diode)





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Figure 7. Relative variations of dynamic parameters versus junction temperature (reference: $T_i = 125^{\circ}$ C)

2.4 2.2 2.0 S factor 1.8 1.6 1.4 1.2 1.0 0.8 0.6 0.4 0.2 T_j(°C) 0.0 5 50 75 100

Figure 8. Transient peak forward voltage versus dl_F/dt (90% confidence, per diode)

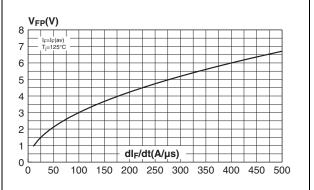
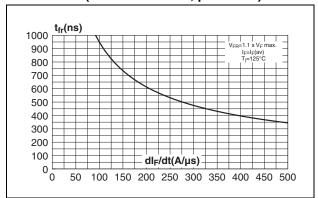


Figure 9. Forward recovery time versus dl_F/dt (90% confidence, per diode)





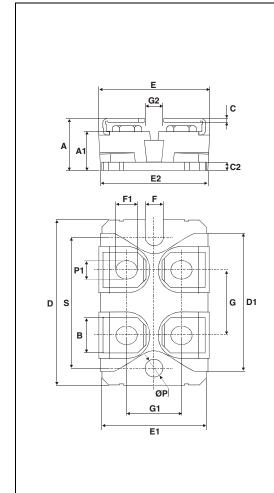
STTH20003TV Package information

2 Package information

Epoxy meets UL94, V0

Cooling method: by conduction (C)
Recommended torque value: 1.3 Nm
Maximum torque value: 1.5 Nm

Table 5. ISOTOP Dimensions



	Dimensions				
Ref.	Millim	neters	Inc	hes	
	Min.	Max.	Min.	Max.	
Α	11.80	12.20	0.465	0.480	
A1	8.90	9.10	0.350	0.358	
В	7.8	8.20	0.307	0.323	
С	0.75	0.85	0.030	0.033	
C2	1.95	2.05	0.077	0.081	
D	37.80	38.20	1.488	1.504	
D1	31.50	31.70	1.240	1.248	
Е	25.15	25.50	0.990	1.004	
E1	23.85	24.15	0.939	0.951	
E2	24.80 typ.		0.976 typ.		
G	14.90	15.10	0.587	0.594	
G1	12.60	12.80	0.496	0.504	
G2	3.50	4.30	0.138	0.169	
F	4.10	4.30	0.161	0.169	
F1	4.60	5.00	0.181	0.197	
Р	4.00	4.30	0.157	0.69	
P1	4.00	4.40	0.157	0.173	
S	30.10	30.30	1.185	1.193	

In order to meet environmental requirements, ST offers these devices in ECOPACK® packages. These packages have a lead-free second level interconnect. The category of second level interconnect is marked on the package and on the inner box label, in compliance with JEDEC Standard JESD97. The maximum ratings related to soldering conditions are also marked on the inner box label. ECOPACK is an ST trademark. ECOPACK specifications are available at: www.st.com.





Ordering information

STTH20003TV

3 Ordering information

Ordering type	Marking	Package	Weight	Base qty	Delivery mode
STTH20003TV	STTH20003TV	ISOTOP	27 g (without screws)	10 (with screws)	Tube

4 Revision history

Date	Revision	Description of Changes
1999	2C	First issue
5-Sep-2006	2	Reformatted to current standards. Thermal resistance updated in Table 2.



Distributor of STMicroelectronics: Excellent Integrated System Limited

Datasheet of STTH20003TV1 - DIODE MODULE 300V 100A ISOTOP

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STTH20003TV

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